

Full Thermoelectric Characterization of Stoichiometric Electrodeposited Thin Film Tin Selenide (SnSe)

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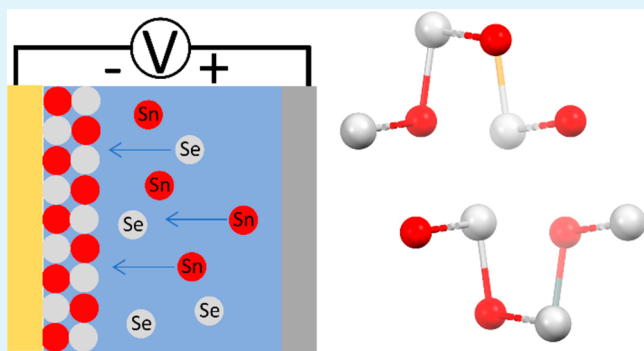
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ABSTRACT: Tin selenide (SnSe) has attracted much attention in the thermoelectric community since the discovery of the record figure of merit (ZT) of 2.6 in single crystal tin selenide in 2014. There have been many reports since of the thermoelectric characterization of SnSe synthesized or manufactured by several methods, but so far none of these have concerned the electrodeposition of SnSe. In this work, stoichiometric SnSe was successfully electrodeposited at -0.50 V vs SCE as shown by EDX, XPS, UPS, and XRD. The full ZT of the electrodeposits were then measured. This was done by both a delamination technique to measure the Seebeck coefficient and electrical conductivity which showed a peak power factor of 4.2 and $5.8 \mu\text{W m}^{-1} \text{K}^{-2}$ for the as deposited and heat-treated films, respectively. A novel modified transient 3ω method was used to measure the thermal conductivity of the deposited films on the deposition substrate. This revealed the thermal conductivity to be similar to the ultralow thermal conductivity of single crystal SnSe, with a value of $0.34 \text{ W m}^{-1} \text{K}^{-1}$ being observed at 313 K.

KEYWORDS: thermoelectrics, electrodeposition, tin selenide, SnSe, thin film, thermal conductivity



INTRODUCTION

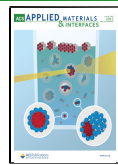
The effects of climate change require greener forms of energy to be developed, while around a sixth of industrial energy is lost as heat.¹ Thermoelectric generators are solid-state technologies that can harvest some of that waste heat energy. For example, thermoelectrics are being developed as a power source for self-powered devices on the Internet of things.^{2,3} The performance indicator that is used to compare the ability of a material to harvest the waste heat is called the figure of merit (ZT), which is dependent on the interrelated material properties of electrical conductivity (σ , S m^{-1}), Seebeck coefficient (S , V K^{-1}), thermal conductivity (κ , $\text{W m}^{-1} \text{K}^{-1}$), and the absolute temperature (T , K) as shown in eq 1.⁴

$$ZT = \frac{\sigma S^2}{\kappa} T \quad (1)$$

A ZT of 1 was achieved in bismuth telluride and lead telluride in the 1950s,^{5,6} and ever since they have been the benchmark materials for room and medium temperature applications, respectively. Thermoelectric generators have had a degree of commercial success in space⁷ and wearable (wrist watch)⁸ applications, or use as Peltier coolers,⁹ but this has been limited. This is because until recently there has only been a modest increase in ZT , and Te is a rare earth element with an abundance in the earth's crust similar to Pt ($1 \mu\text{g kg}^{-1}$).¹⁰

In 2014, Zhao et al. reported tin selenide (SnSe) to have the highest ZT ever recorded of 2.6 at 923 K along the b -axis.¹¹ Of note, however, is that the average ZT along this axis through the temperature range studied (303–973 K) was 0.95, with the peak ZT being 2.3 and 0.84 and average ZT being 0.85 and 0.29 for the c -axis and a -axis, respectively. In fact, the authors later report the ZT of a device would be as low as 0.23 but highlight that through hole doping this can be increased to 1.34. This was shown to be higher than lead telluride examples.^{12–14} Since 2014, SnSe has been shown to be fabricated through a variety of different techniques in the literature. These include solvothermal synthesis (SS)^{15–17} or melting (M),^{18–21} followed by spark plasma sintering (SPS).^{15–22} Other techniques include cold pressing (CP),²³ hot pressing (HP),^{24,25} thermal evaporation,^{26,27} and printing.²⁸ Many of these techniques require high temperature, high pressure, and lengthy fabrication times. In contrast, electrodeposition is a fabrication technique that is low-cost, mature,

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and a scalable industrial technique compatible with high-throughput continuous manufacturing.^{29,30} Electrodeposition of SnSe has been sparsely reported in the literature,^{31,32} and there are no reports of the thermoelectric performance of electrodeposited SnSe.

In this study we report the successful electrodeposition of thin films of SnSe. The materials properties are extensively studied through a combination of SEM, EDX, XRD, XPS, and XRD. The full thermoelectric figure of merit (ZT) is also measured, with the Seebeck coefficient and electrical conductivity measured through delamination and the thermal conductivity measured by the in-plane 3ω method.

EXPERIMENTAL SECTION

Thin Film Fabrication: Deionized water (>17.2 Mohm) was taken from a Purite (L300450); to this NaOH pellets (Sigma-Aldrich, 98–100.5%) were added until a pH of 12 was attained. To this NaOH solution, 12 mM EDTA (Sigma-Aldrich, 99%) was added. The solution was set to stir until full dissolution of EDTA was achieved. If needed, extra NaOH was added to facilitate full dissolution. To 50 mL of this EDTA solution, 10 mM $\text{SnCl}_2 \cdot 2\text{H}_2\text{O}$ (Sigma-Aldrich, >98%) was added. The solution was set to stir, while nitrogen was simultaneously gently bubbled through the solution. Once Sn dissolution was realized, 2.5 mM Na_2SeO_3 (Sigma-Aldrich, 99%) was added to the stirring solution. Finally, 0.2 M H_2SO_4 was added until the pH of the solution was 2.5. The stirring was then halted, and after 5 min the nitrogen was turned off. Once the nitrogen was turned off, the deposition was started. All electrochemical experiments used an Ivium (CompactStat.e) potentiostat. The deposition was conducted via chronoamperometry, with a deposition potential of -0.5 V vs SCE. The deposition time was 5400 s. The counter electrode used was a Pt gauze electrode, with a surface area far in excess of the working electrode. The Pt gauze was cleaned in a blue flame and allowed to cool, prior to immersion into the electrolyte. The reference electrode was a commercial saturated calomel electrode (SCE) from Sentek. For all samples, except thermal conductivity samples, the working electrode composed of Si wafers (p-type (100)) with a 20 nm sputtered Cr adhesion layer, followed by a 200 nm sputtered Au layer. For electrical and Seebeck measurements, the electrodeposited films were delaminated onto 2 mm glass using 2 part epoxy as previously reported in the literature.^{33–38} For thermal conductivity measurements, samples were deposited onto Linseis Thin Film Analyzer “ZT chips” with a contact layer of 15 nm layer Cr evaporated onto the sample area followed by 75 nm of Au. Full details of the measurement process are in the Supporting Information and elsewhere.^{39,40} The Linseis Thin Film Analyzer measures total thermal conductance of all materials deposited onto the measurement chip plus the contribution of the chip itself, so the thermal conductivity of SnSe on its own was measured by subtracting a measurement of the chip with Cr/Au electrode that was made before SnSe deposition. Working electrode areas were defined with Kapton tape, and Cu tape was used to make electrical contact between the working electrode and the potentiostat during electrodeposition.

Sample Curing: All curing of samples was performed inside an ULVAC ZEM3, as the atmosphere, cure time, and temperature could easily be controlled. The samples were laid face up inside a Ni shield and were not placed between any of the 4-point probes found inside the machine. All cure times were 30 min in a helium atmosphere of 1 atm, with the temperature ramped from room temperature to cure temperature in ~ 5 min.

Material Characterization: Sample thicknesses were measured by using a Dektak 150 surface profilometer, with all the thicknesses of all samples determined to be within 8 ± 1 μm . XRD was performed on a Bruker D8 diffractor with Cu $K\alpha$ radiation and a 1D LYNXEYE detector. The voltage and current were 40 kV and 40 mA, respectively, and a step size of 0.02° was used. In the Bragg–Brentano setup a 0.3 mm divergent slit was used, while in the grazing incidence setup a 2° incidence angle was used with a Göebel mirror

and a 0.6 mm slit on the primary arm. SEM and EDX were performed on a Joel 7800F field emission gun (FEG) SEM with an Oxford Laboratory EDX attachment with an accelerating voltage of 10 kV and a working distance of 10 mm.

X-ray photoelectron spectroscopy (XPS) and ultraviolet photoelectron spectroscopy (UPS) were performed on a Kratos Axis Supra instrument. Data were processed with CasaXPS (2.3.23rev1.1K). Samples were mounted in electrical contact with the stage to enable a 9 V sample bias during UPS. The Fermi edge of a Ag control, freshly cleaned by Ar^+ etching, was used to calibrate the energy scale to 0 eV. XPS wide scan data can be seen in Figure S3f. XPS high-resolution samples were etched to a depth of <10 nm by using a monochromatic Al $K\alpha$ source (225 W, 15 mA) with a typical footprint of $\sim 300 \times 700$ μm^2 and collected with a pass energy of 20 eV. Spectra were fitted with Shirley backgrounds, and synthetic components used the GL(70) line shape. As samples are electrically connected to ground, no charge correction is applied. For UPS the kinetic energy values of the secondary electron cut off and valence band maximum were determined by fitting tangents using the “step up” and “step down” “backgrounds” in CasaXPS applied to a He(I) (21.21 eV) photoemission spectrum collected with a 10 eV pass energy. A typical error quoted by the instrument manufacturer is ± 0.13 eV.

Electrical conductivity and Seebeck coefficients were measured on a commercial ULVAC ZEM3 in a helium atmosphere; silver conductive paint (Electrolube) was added to the top and bottom to make electrical contacts. The ULVAC ZEM3 employs a 4-point probe to measure the electrical conductivity. Each Seebeck coefficient was determined by performing three differential temperature voltage measurements, taking the gradient of the results, and correcting for the internal wire Seebeck of the instrument. In-plane thermal conductivity was measured under vacuum on a test chip by a modified in-plane 3ω method with a Linseis Thin Film Analyzer (see the Supporting Information for full details).

RESULTS AND DISCUSSION

Cyclic voltammetry, as shown in Figure 1, was utilized to confirm the deposition potential for SnSe. An anodic current

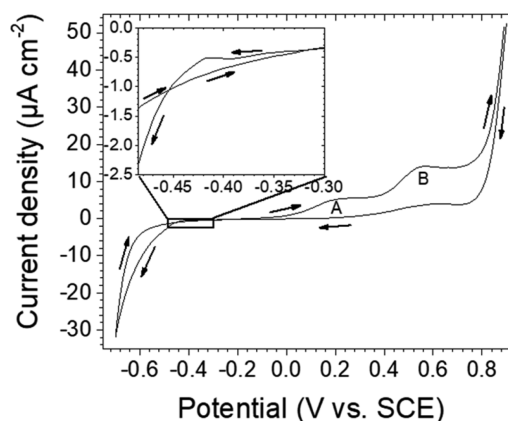


Figure 1. Cyclic voltammogram of 12 mM EDTA, 10 mM SnCl_2 , and 2.5 mM Na_2SeO_3 in deionized water, acidified to a pH of 2.5 with H_2SO_4 . The starting potential was $+0.9$ V vs SCE, with the vertex voltage at -0.7 V vs SCE before finishing at the starting voltage. The scan rate was 100 mV s^{-1} .

can be seen from -0.20 V vs SCE onward. The current begins to sharply increase from around -0.4 V vs SCE, which is consistent with where the onset of hydrogen evolution would be seen in an aqueous electrolyte at a pH of 2.5. The onset of oxygen evolution is seen at just over $+0.8$ V vs SCE, which is again consistent with a pH of 2.5. On the reverse scan a nucleation loop can be observed (as highlighted in the Figure 1

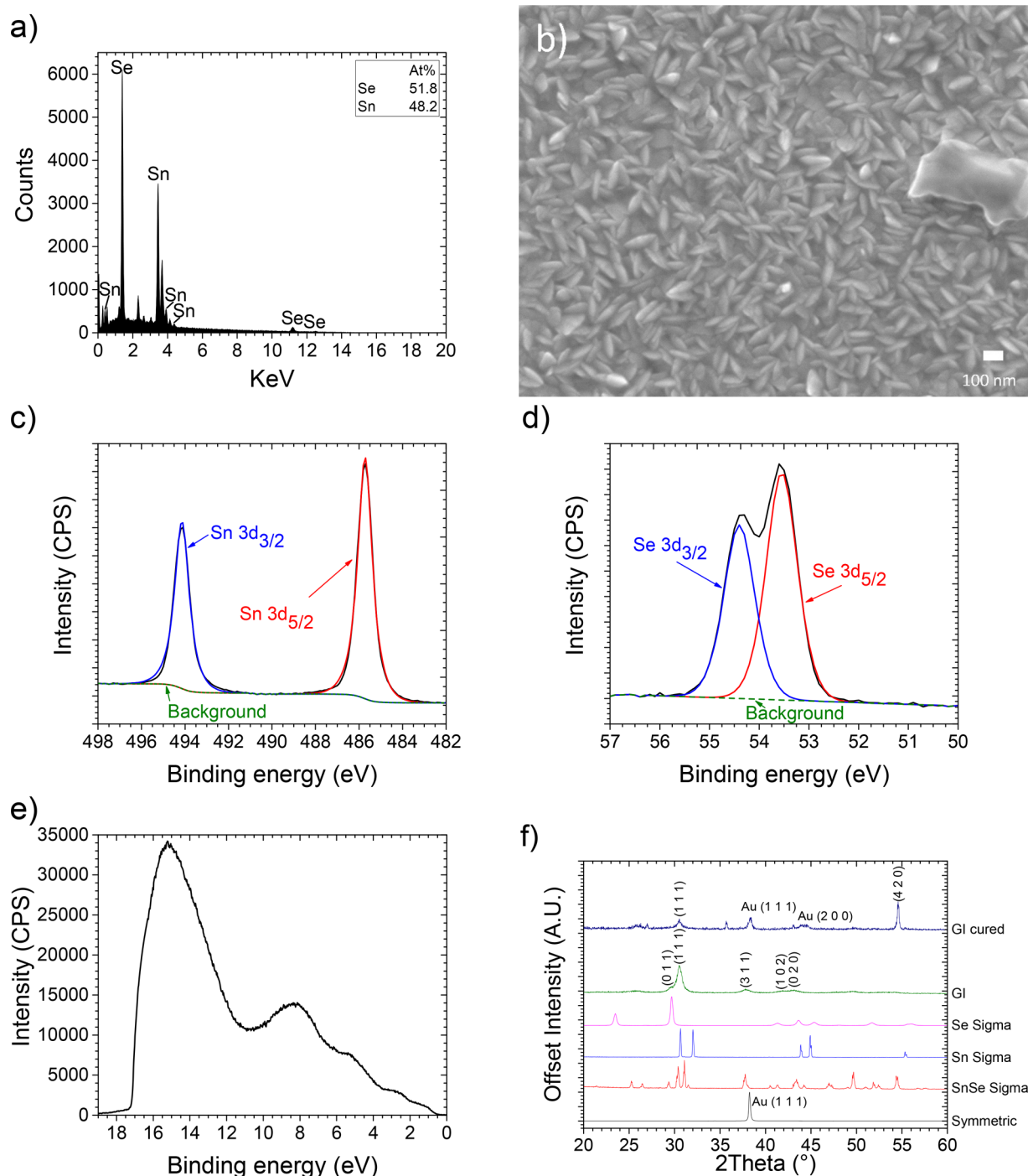


Figure 2. Material characterization of electrodeposited SnSe: (a) EDX spectrum. (b) SEM of surface morphology. (c, d) XPS showing Sn_{3d} and Se_{3d} peaks, respectively. (e) UPS spectrum. (f) XRD scans of the electrodeposited film in Bragg–Brentano (symmetric) and grazing incidence (GI) setup both before and after a cure at 450 K in He and Bragg–Brentano scans of SnSe, Sn, and Se powder purchased from Sigma-Aldrich.

inset), which is indicative of a deposition having been formed on the electrode. On the forward scan two further features can be seen, which are labeled A and B in Figure 1; these correlate to the stripping of Sn and Se, respectively, as can be seen in the Supporting Information (Figure S2). A deposition potential of -0.50 V vs SCE was thus determined. This was consistent with optimal results from the literature,³² where only the photoactivity of the electrodeposits was studied.

To confirm the electrodeposit was SnSe, a variety of characterization techniques were conducted which can be seen

in Figure 2. EDX revealed a bulk stoichiometry of near 1:1 Sn:Se ratio with a slight Se excess (Figure 2a), although this is within error of the measurement. EDX of heat-treated electrodeposited SnSe (Figure S3e) reveals a slight Sn enrichment postcuring compared to precuring, although again this is within error of the measurement. Stoichiometry measured by XPS revealed a slight Sn enrichment, with a Sn:Se ratio of 1.6:1, which is consistent with previously examined SnSe materials.^{26,28} The stoichiometric difference between XPS and EDX can be explained due to XPS only having a

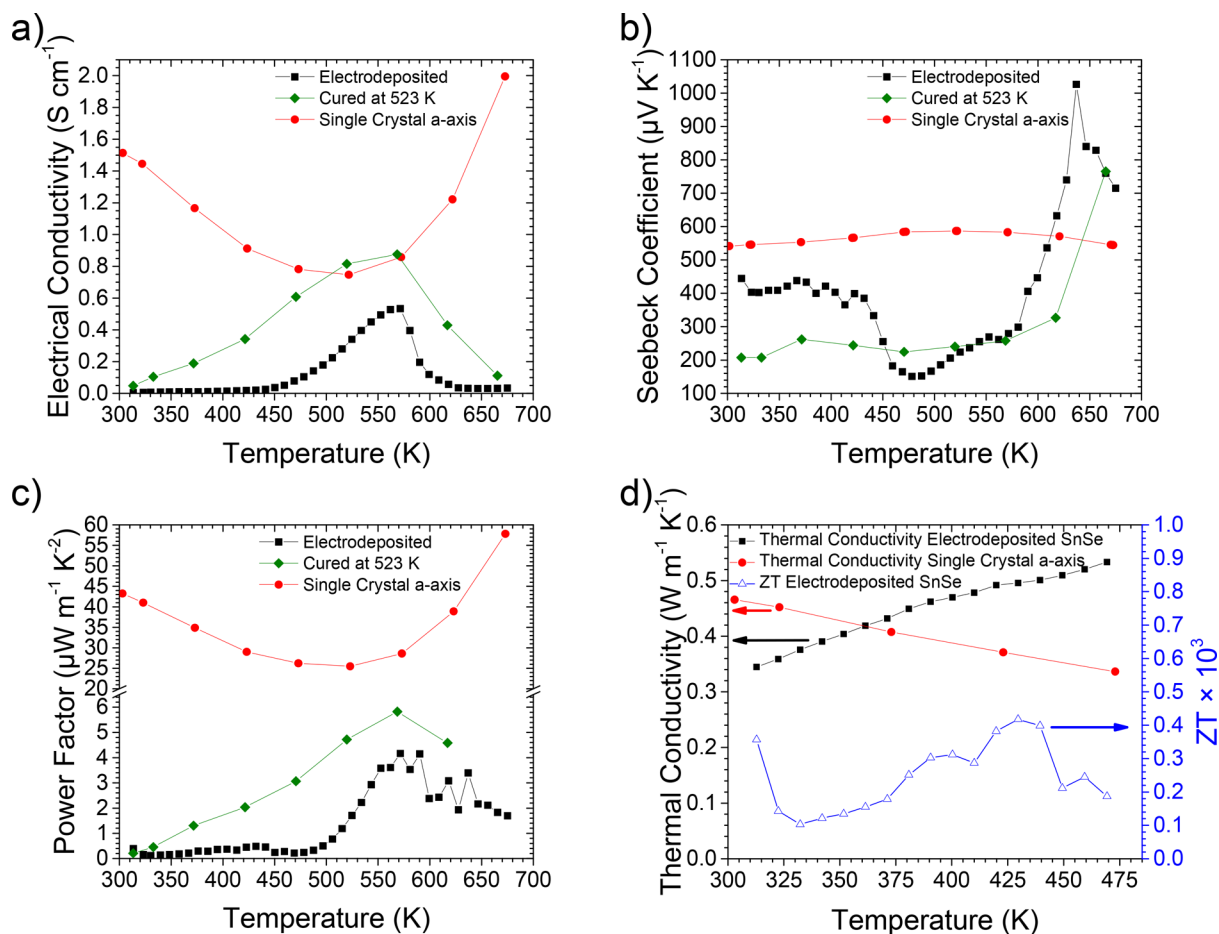


Figure 3. Thermoelectric characterization of electrodeposited SnSe both uncured and cured at 523 K in He for 30 min compared to the *a*-axis of single crystal SnSe.¹¹ (a) Electrical conductivity, (b) Seebeck coefficient, (c) power factor, and (d) thermal conductivity and ZT.

penetration depth in the region of 10 nm; therefore, while the bulk stoichiometry is revealed to be near ideal by EDX, XPS reveals a slight Sn surface enrichment. A single sharp doublet is observed for the Sn(3d) electrons (Figure 2c), with the larger 3d_{5/2} peak (FWHM 0.86 eV) at 485.7 eV, which is consistent with crystalline SnSe, and notably higher than would be expected for a metallic Sn at 485.1 eV.⁴¹ Similarly the Se 3d doublet (Figure 2d) yields a sharp Se 3d_{5/2} peak (FWHM 0.73 eV) at 53.5 eV, which is consistent with SnSe and markedly shifted from the position of 55.2 eV expected for elemental Se. Taken together, the Sn and Se XPS peaks suggest that the electrodeposit is formed from SnSe.

UPS (Figure 2e) revealed a kinetic energy value for the work function of the electrodeposit of 3.89 eV, which is consistent within error of density functional theory calculations of 3.91 eV for α -SnSe.⁴² Scanning electron microscopy images (Figure S3a) reveal a porous morphology often seen for electrodeposits. Bragg–Brentano (symmetric) XRD as shown in Figure 2f is dominated by the underlying gold substrate; therefore, grazing incidence XRD was conducted. Grazing incidence reveals peaks that are attributed to SnSe; however, the lack of strong peaks indicates a high level of disorder in the SnSe electrodeposit. After curing at 473 K for 30 min in a He atmosphere of 1 atm, a strong additional XRD peak is revealed, suggesting a reduction in the disorder, an increase in the crystallinity, and a change of orientation. Low-resolution SEM (Figure S3b) reveals a stark change in morphology after heat treatment compared to preheat treatment (Figure S3a), while

higher resolution SEM (Figure S3c and Figure 2b) reveals minimal changes in morphology. These results indicate that the large-scale porosity of the non-heat-treated films is removed through an annealing densification process, while the small-scale structure is largely unaffected.

In-plane thermolectric characterization of the uncured and cured at 523 K in He electrodeposited films is shown in Figure 3. Measurements of a separate uncured electrodeposited SnSe film can be seen in Figure S4. The electrical conductivity (Figure 3a) of the uncured sample is seen to be initially significantly lower than was observed in single crystal SnSe.¹¹ This can be explained by the high level of disorder and porosity in the electrodeposit as observed by XRD (Figure 2f). A sharp increase in the electrical conductivity is seen at 450 K, which can be attributed to annealing of the film causing densification and an increase in the film's crystallinity. These annealing effects elevate the electrical conductivity of electrodeposited SnSe to 0.53 S cm⁻¹ at 570 K, which is near that of the *a*-axis of single crystal SnSe which is 0.86 S cm⁻¹ at 572 K.¹¹ In general, though, the electrical conductivities of these films are significantly lower than that of single crystal SnSe. This can be explained from two factors. First, the films exhibit a reasonable degree of porosity, as can be seen in the low-resolution SEM in Figure S3a, which acts to reduce electrical conductivity. Second, delamination from the deposition substrate ultimately caused cracking across the film (Figure S3d). Collectively, these contributed to the lower electrical conductivity observed in these films. After curing in He at 523

K for 30 min, the electrical conductivity is seen to be higher compared to that of the uncured sample, throughout all temperatures observed. The electrical conductivity is briefly seen to be higher than that observed in the *a*-axis of single crystal SnSe between 520 and 570 K. The uncured films exhibit Seebeck coefficients of a similar magnitude to those seen in single crystal SnSe at room temperature.¹¹ As would be expected, the Seebeck coefficient also changes sharply around 450 K, with the drop being due to the electrical conductivity and the Seebeck coefficient having a direct and inverse correlation with carrier concentration, respectively.⁴ Interestingly the cured film does not exhibit the sharp change in the Seebeck coefficient around 450 K that was seen in the noncured film, which confirms that this is an irreversible change from curing rather than a phase change. The Seebeck coefficient of the cured film is instead seen to slightly increase with temperature, the same trend as seen in single crystal SnSe. The resulting power factors (Figure 3c) are around 10 times lower than is seen in single crystal SnSe,¹¹ with the cured film exhibiting higher power factors throughout compared to the uncured film. The thin film SnSe power factor seen here is comparable to SnSe thin films in the literature prepared by using other methods (Figure S4d), such as thermal evaporation,²⁶ thermal coevaporation,²⁷ and chemical vapor deposition.⁴³ Electrodeposition is, however, preferable to these techniques, as it is more easily scaled to thick films.²⁹ The power factors of the electrodeposited films could not be measured beyond 675 K due to thermal stress on the thin films, causing excess films fractures; these fractures were clearly visible on the films post measurements. The cracking process most likely starts at just above 570 K due to the decline in electrical conductivity at that temperature being observed in all the samples and no fractures being visible when samples were cured at 523 K. Nevertheless, 675 K is still higher than any other temperature SnSe thin films have been measured before (Figure S4d). Thermal conductivity values (Figure 3d) of the as-deposited films were measured via a modified transient 3ω ; these were observed to be comparable to those seen in single crystal SnSe by Zhao et al.¹¹ Temperature and thermal conductivity are, however, in contrast to Zhao et al. seen to have a positive correlation in the temperature range 300–470 K, which is typical of disordered films and arises from the boundaries within the films. The thermal conductivity measurement was cycled four times (Figure S5), which showed minimal changes in the thermal conductivity, although a slight increase was observed on each cycle. The boundaries along with delamination cracking and porosity ultimately explain the low ZT (Figure 3d) value observed in the film up to 470 K. Although we expect the sharp increase in the power factor above 470 K to cause a similar increase in ZT, we were unable to measure the thermal conductivity in this temperature range.

CONCLUSION

In conclusion, $\sim 8 \mu\text{m}$ thick films of SnSe were fabricated onto a Au substrate via a simple electrodeposition process. While XPS and EDX confirmed the deposition was SnSe, XRD revealed that the as-deposited material exhibited a low level of crystallinity. This could also be seen in the positive correlation between thermal conductivity and temperature. The Seebeck coefficients of the SnSe electrodeposits at room temperature were similar to single crystal SnSe; however, because of the low crystallinity, porosity, and cracked nature of the delaminated

films, the electrical conductivity was seen to be significantly lower below 450 K. Remarkably, the films annealed above 450 K, which resulted in a densification and a significant improvement in the electrical conductivity to near single crystal SnSe levels. The thermal conductivity was also measured to be comparable to that seen in single crystal SnSe. This observation represents an important step in developing thick film metal chalcogenide thermoelectrics that are deposited by scalable methods.

ASSOCIATED CONTENT

Supporting Information

The Supporting Information is available free of charge at <https://pubs.acs.org/doi/10.1021/acsami.0c06026>.

Detailed description of thermal conductivity measurement, CVs of Sn and Se precursors, SEM of as deposited and cured and delaminated electrodeposited SnSe films, EDX of cured film, XPS wide scan, thermoelectric comparison of 2 samples, comparison of power factor to the literature, thermal conductivity hysteresis measurement (PDF)

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Author Contributions

The experiments were led by M.R.B., with M.R.B. and C.B. conducting all experiments, with the exception of thermal conductivity measurements done by T.L. and O.F., while XPS and UPS experiments were conducted by J.M. The bulk of the manuscript was written by M.R.B., with T.L. and O.F. contributing to the thermal conductivity sections and J.M. contributing to the XPS and UPS sections. All other authors proofread the manuscript and have given approval to the final version of the manuscript.

Notes

The authors declare no competing financial interest.

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ABBREVIATIONS

CV, cyclic voltammetry; XRD, X-ray diffraction; EDX, energy-dispersive X-ray spectroscopy; XPS, X-ray spectroscopy; UPS, ultraviolet photoelectron spectroscopy.

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